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RESPONSE DUE UNDER  
37 C.F.R. §1.116  
EXPEDITED PROCEDURE  
EXAMINING GROUP 2823

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of:

DALSON YE SENG KIM  
JEFFREY TOH TUCK FOOK  
LEE CHOON KUAN

Serial No. 10/633,434

Art Unit: 2823

Filing Date: 08/01/2003

Examiner: Lee, Hsien Ming

For: Semiconductor Component Having  
Chip On Board Leadframe  
(As Amended)

Attorney Docket No. 02-1467

**AMENDMENT AFTER FINAL**

**November 3, 2004**

Mail Stop AF  
Commissioner For Patents  
PO Box 1450  
Alexandria, VA 22313-1450

Sir:

This Amendment is in response to the final Office Action dated 10/28/2004, having a statutory period for response set to expire on 01/28/2005. Please amend the case as follows.

OK  
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enter  
1/7/05